AMENDMENTS TO THE CLAIMS

19-49. (Cancelled)

50. (Currently Amended) A method of during the manufacture of a slider member to be used in sliding relation to an other member, forming micro-protrusions on or micro-cavities in a surface of a substrate from which is formed said the slider member, in a manner to reduce sticking between said the surface and the other member and to reduce entrapment of foreign particles therebetween, said method comprising:

placing said the substrate in a process chamber;

supporting a mask member in front of said the surface of said the substrate, said the mask member disposed in contact with or in proximity of said the substrate surface, and the mask member having a plurality of cavities arranged as a matrix-type on a plate;

irradiating fast atomic beams through said the mask member onto said the surface of said the substrate, and thereby forming said the micro-protrusions or said the micro-cavities, said forming comprising controlling said irradiating such that each micro-protrusion or micro-cavity has a top or bottom surface, respectively, and a side surface, with said the side surface extending at an inclusive angle of from approximately 80° to approximately 110° to an intended direction of sliding of said the slider member relative to the other member and to said the surface of said the substrate, wherein the micro-protrusions or micro-cavities have a height or depth ranging from 10 to 50 nm and 10 to 1,000,000 micro-protrusions or micro-cavities are formed on a 1mm² surface of the substrate; and

forming a magnetic film layer and a protective film layer on said the micro-protrusions or said the micro-cavities.

51. (Currently Amended) A method as claimed in claim 50, wherein said the mask member has a plurality of openings arranged in a matrix-type array formed on a plate.

- 52. (Currently Amended) A method as claimed in claim 51, wherein said the opening is circular-shaped, oval-shaped, squire-shaped square-shaped or honeycomb-shaped.
- 53. (Currently Amended) A method as claimed in claim 51, wherein said the opening is rhombus-shaped or hexagonal-shaped.
- 54. (Currently Amended) A method as claimed in claim 50, wherein said the slider member comprises a magnetic disc or a magnetic head.
- 55. (Currently Amended) A method as claimed in claim 50, wherein said the surface of the substrate comprises glass.
- 56. (Currently Amended) A method as claimed in claim 50, wherein said irradiating comprises directing, said the fast atomic beams from a beam source at an angle of incidence determined by an angle of inclination measured with respect to a rotation axis normal to said the surface of said the substrate, and rotating one of said the beam source and said the substrate about said the rotation axis relative to the other of said the beam source and said the substrate.
- 57. (Currently Amended) A method as claimed in claim 50, wherein said irradiating comprises a first irradiation operation of irradiating said the fast atomic beams through a first mask member comprising parallel wires or rods disposed adjacent to said the surface of said the substrate, and a second irradiation operation of irradiating said the fast atomic beams through a second mask member comprising parallel wires or rods disposed adjacent to said the surface of said the substrate.
- 58. (Currently Amended) A method as claimed in claim 50, wherein said the protective layer comprises carbon, SiO₂, or ceramic material.

- 59. (Currently Amended) A method as claimed in claim 50, wherein said irradiating comprises directing said the fast atomic beams substantially at a right angle onto said the surface of said the substrate.
- 60. (Currently Amended) A method as claimed in claim 50, wherein said the angle is from approximately 90° to approximately 110°.
- 61. (Currently Amended) A method as claimed in claim 50, wherein said the angle is from approximately 80° to approximately 90°.
- 62. (Currently Amended) A method as claimed in claim 50, wherein said the angle is substantially 90°.
- 63. (Currently Amended) A method as claimed in claim 50, wherein said the mask member comprises micro-objects dispersed on said the surface of said the substrate.
- 64. (Currently Amended) A method as claimed in claim 63, wherein said the micro-objects comprise micro-particles of powder.
- 65. (Currently Amended) A method as claimed in claim 63, wherein said the micro-objects are formed from at least one material selected from the group consisting of alumina, carbon, Si₃N₄, SiC, TiN, ZrO₂, MgO and synthetic resin.
- 66. (Currently Amended) A method as claimed in claim 64, wherein said the micro-objects are susceptible to etching by said the fast atomic beams.
- 67. (Currently Amended) A method as claimed in claim 64, wherein said the micro-objects are not susceptible to etching by said the fast atomic beams.

- 68. (Currently Amended) A method as claimed in claim 50, wherein said the mask member comprises a plurality of fine wire or rod members disposed adjacent said the surface of said the substrate.
- 69. (Currently Amended) A method as claimed in claim 68, wherein said the plurality of wire or rod members extend parallelly.
- 70. (Currently Amended) A method as claimed in claim 68, wherein said the plurality of wire or rod members are arranged to form a matrix.
- 71. (Currently Amended) A method as claimed in claim 50, wherein said the micro-protrusions or micro-cavities have a height or depth of approximately 10nm.
- 72. (Currently Amended) A method of, during the manufacture of a slider member to be used in sliding relation to an other member, forming micro-protrusions on or micro-cavities in a surface of said the slider member in a manner to reduce sticking between said the surface and the other member and to reduce entrapment of foreign particles therebetween, said method comprising:

depositing a protective film layer on a substrate;

placing said the substrate in a process chamber;

supporting a mask member in front of said the surface of said the protective film layer, said the mask member disposed in contact with or in proximity of said the surface, and the mask member having a plurality of cavities arranged as a matrix-type on a plate;

irradiating fast atomic beams through said the mask member onto said the surface of said the protective film layer, and thereby forming said the micro-protrusions or said the micro-cavities, said forming comprising controlling said irradiating such that each micro-protrusion or micro-cavity has a top or bottom surface, respectively, and a side surface, with said the side surface extending at an inclusive angle of from approximately 80° to approximately 110° to an intended direction of sliding of said the slider member relative to the other member and to the surface of the substrate, wherein

the micro-protrusions or micro-cavities have a height or depth ranging from 10 to 50 nm and 10 to 1,000,000 micro-protrusions or micro-cavities are formed on a 1 mm² surface of the substrate.

- 73. (Currently Amended) A method as claimed in claim 72, wherein said the protective layer comprises carbon, SiO₂, or ceramic material.
- 74. (Previously presented) A method as claimed in claim 72, wherein a magnetic film layer is formed between the protective film layer and the substrate.
- 75. (Currently amended) A method of, during the manufacture of a slider member to be used in sliding relation to an other member, forming micro-protrusions on or micro-cavities in a surface of a substrate from which is formed said the slider member, in a manner to reduce sticking between said the surface and the other member and to reduce entrapment of foreign particles therebetween, said method comprising:

placing said the substrate in a process chamber, wherein said the substrate has a smooth curved sliding surface;

supporting a mask member in front of said the surface of said the substrate, said the mask member disposed in contact with or in proximity of a portion of said the substrate surface, and the mask member having a plurality of cavities arranged as a matrix-type on a plate;

irradiating fast atomic beams through said the mask member onto said the surface of said the substrate, and thereby forming said the micro-protrusions or said the micro-cavities, said forming comprising controlling said irradiating such that each micro-protrusion or micro-cavity has a top or bottom surface, respectively, and a side surface, with said the side surface extending at an inclusive angle of from approximately 80° to approximately 110° to an intended direction of sliding of said the slider member relative to the other member, wherein the micro-protrusions or micro-cavities have a height or depth ranging from 10 to 50 nm and 10 to 1,000,000 micro-protrusions or micro-cavities are formed on a 1 mm² surface of the substrate.

- 76. (Currently Amended) A method as claimed in claim 75, wherein said the slider member comprises a magnetic head.
 - 77. (Currently Amended) A method as claimed in claim 75, further comprising: forming a protective film layer on said the micro-protrusions or said the micro-cavities.
- 78. (New) A method of manufacturing a slider member to be used in sliding relation to an other member, said slider member being a thrust bearing housing, said method comprising:

placing a cylindrical body of the thrust bearing housing in a process chamber;

disposing a plurality of wires arranged radially on a surface of the cylindrical body;

irradiating fast atomic beams toward the plurality of wires onto a surface of the cylindrical body, and forming micro-protrusions or micro-cavities, said forming comprising controlling said irradiating such that each micro-protrusion or micro-cavity has a top or bottom surface, respectively, and a side surface, with the side surface extending at an inclusive angle of from approximately 80° to approximately 110° to an intended direction of sliding of the slider member relative to the other member.

79. (New) A method of, during the manufacture of a slider member to be used in sliding relation to an other member, forming micro-protrusions on or micro-cavities in a surface of a substrate from which is formed the slider member, in a manner to reduce sticking between the surface and the other member and to reduce entrapment of foreign particles therebetween, said method comprising:

placing the substrate in a process chamber;

supporting a mask member in front of the surface of the substrate, the mask member disposed in contact with or in proximity of the substrate surface;

irradiating fast atomic beams through the mask member onto the surface of the substrate, and forming said micro-protrusions or said micro-cavities, said forming comprising controlling said irradiating such that each micro-protrusion or micro-cavity has a top or bottom surface, respectively,

and a side surface, with the side surface extending at an inclusive angle of from approximately 80° to approximately 110° to an intended direction of sliding of the slider member relative to the other member and to the surface of the substrate, wherein the micro-protrusions or micro-cavities are two-stage protrusions having a plurality of top-stage protrusions and lower-stage protrusions; and

forming a magnetic film layer and a protective film layer on the micro-protrusions or the micro-cavities.